



Product Change Notification (PCN) Announcement

Title	DDR2 Product change Notice for Micron 800 1Gb M-die assembled 1GB products	Date	2026/Aug/31	Ref No.	D260816
Models	DDR2 1GB DRAM Modules				
Level	☐ Critical ☒ Major ☐ Minor ☐ Notice	Change Type	Hardware - IC		
Description					
Due to changes in supply conditions, Innodisk hereby announces the product change plan for Micron DDR2 800 1Gb M-die assembled 1GB products.					
Description:					
DIMM Type	Old		New		
DDR2 800 1GB SODIMM	Micron IC	DDR2 800 64Mx16 M-die (MT47H64M16NF-25E:M)	Promos IC	DDR2 800 128Mx8 E-die (V59C1G01808QEJ25)	

Affected Component Table	
Current Part Number	New Part Number
M2SK-1GMDAC05-M%	M2SK-1GPF5C06-E
M2SK-1GMDAC06-M%	M2SK-1GPF5C06-E
M2SK-1GMDACH4-M%	M2SK-1GPF5CH4-E
M2SK-1GMDACJ5-M%	M2SK-1GPF5CJ5-E

Note
(1) For the availability of the replacement samples (if applicable), please contact the salesperson and the local PM. (2) No response from customers will be deemed as acceptance of the change, which will be implemented according to the key milestones. Innodisk apologizes for any inconvenience caused by this and appreciates your understanding. (3) Innodisk promises that new items deliver quality and reliability, and are JEDEC compliant. If there is any further inquiry about our products or product specifications, please contact your Innodisk salesperson for support. (4) Innodisk reserves the right to process the product change if the PN is not listed. (5) The wild cards are represented here by percentage (%).

Key Milestone Dates	
Last Purchase Date	2026/Nov/30
Last Shipment Date	2027/Feb/28
<u>*Recommend action:</u> ☐ Call back ☐ All stock rework ☐ Running change ☒ Cut in Effective date	

Customer Impact of Change and Recommended Action
We will support you in making this transition smoothly to ensure a seamless process (if applicable). Please contact Innodisk sales if you have any inquiries.

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